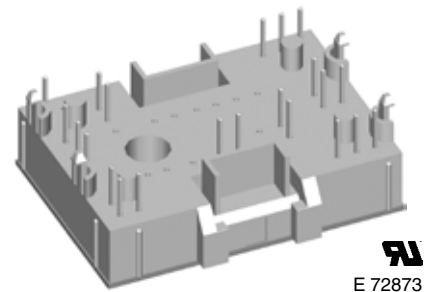
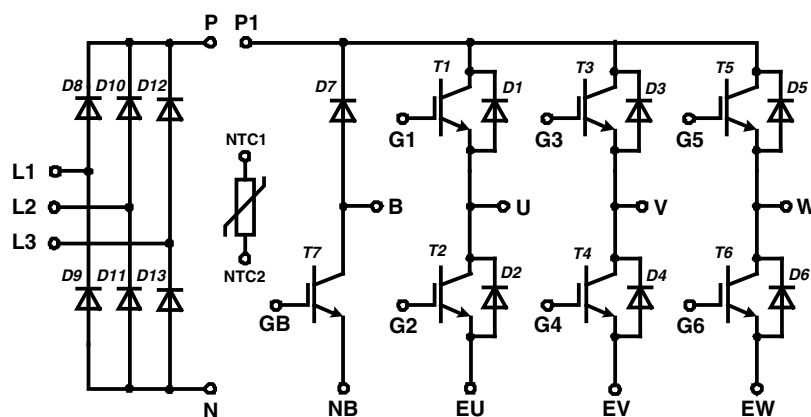


Converter - Brake - Inverter Module XPT IGBT

| Three Phase Rectifier | Brake Chopper | Three Phase Inverter |
|------------------------------|-------------------------------|-------------------------------|
| $V_{RRM} = 1600 \text{ V}$ | $V_{CES} = 1200 \text{ V}$ | $V_{CES} = 1200 \text{ V}$ |
| $I_{DAVM25} = 100 \text{ A}$ | $I_{C25} = 28 \text{ A}$ | $I_{C25} = 28 \text{ A}$ |
| $I_{FSM} = 270 \text{ A}$ | $V_{CE(sat)} = 1.8 \text{ V}$ | $V_{CE(sat)} = 1.8 \text{ V}$ |

Part name (Marking on product)

MIXA20WB1200TMH



E 72873

Pin configuration see outlines.

Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Rugged XPT design (Xtreme light Punch Through) results in:
 - short circuit rated for 10 μsec .
 - very low gate charge
 - square RBSOA @ $3 \times I_c$
 - low EMI
- Thin wafer technology combined with the XPT design results in a competitive low $V_{CE(sat)}$
- Temperature sense included
- SONIC™ diode
 - fast and soft reverse recovery
 - low operating forward voltage

Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

Package:

- "Mini" package
- Assembly height is 17 mm
- Insulated base plate
- Pins suitable for wave soldering and PCB mounting
- Assembly clips available
 - IXKU 5-505 screw clamp
 - IXRB 5-506 click clamp
- UL registered E72873

Output Inverter T1 - T6

| Symbol | Definitions | Conditions | Ratings | | | Unit | |
|--|---------------------------------------|---|---|------------|----------|--------|----------|
| | | | min. | typ. | max. | | |
| V_{CES} | collector emitter voltage | | $T_{VJ} = 25^{\circ}\text{C}$ | | 1200 | V | |
| V_{GES} | max. DC gate voltage | continuous | | | ± 20 | V | |
| V_{GEM} | max. transient collector gate voltage | transient | | | ± 30 | V | |
| I_{C25} | collector current | | $T_C = 25^{\circ}\text{C}$ | | 28 | A | |
| I_{C80} | | | $T_C = 80^{\circ}\text{C}$ | | 20 | A | |
| P_{tot} | total power dissipation | | $T_C = 25^{\circ}\text{C}$ | | 100 | W | |
| $V_{CE(sat)}$ | collector emitter saturation voltage | $I_C = 16\text{ A}; V_{GE} = 15\text{ V}$ | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | 1.8 2.1 | 2.1 | V V | |
| $V_{GE(th)}$ | gate emitter threshold voltage | $I_C = 0.6\text{ mA}; V_{GE} = V_{CE}$ | $T_{VJ} = 25^{\circ}\text{C}$ | 5 | 5.5 | 6.5 | V |
| I_{CES} | collector emitter leakage current | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$ | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | | 0.1 | 0.1 | mA mA |
| I_{GES} | gate emitter leakage current | $V_{GE} = \pm 20\text{ V}$ | | | 500 | nA | |
| $Q_{G(on)}$ | total gate charge | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 15\text{ A}$ | | | 48 | nC | |
| $t_{d(on)}$ | turn-on delay time | inductive load $V_{CE} = 600\text{ V}; I_C = 15\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 56\ \Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ | | 70 | ns | |
| t_r | current rise time | | | | 40 | ns | |
| $t_{d(off)}$ | turn-off delay time | | | | 250 | ns | |
| t_f | current fall time | | | | 100 | ns | |
| E_{on} | turn-on energy per pulse | | | | 1.55 | mJ | |
| E_{off} | turn-off energy per pulse | | | | 1.7 | mJ | |
| RBSOA | reverse bias safe operating area | $V_{GE} = \pm 15\text{ V}; R_G = 56\ \Omega; V_{CEK} = 1200\text{ V}$ | $T_{VJ} = 125^{\circ}\text{C}$ | | 45 | A | |
| I_{SC} (SCSOA) | short circuit safe operating area | $V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V};$ $R_G = 56\ \Omega; t_p = 10\ \mu\text{s};$ non-repetitive | $T_{VJ} = 125^{\circ}\text{C}$ | | 60 | A | |
| R_{thJC} | thermal resistance junction to case | (per IGBT) | | | 1.26 | K/W | |
| R_{thCH} | thermal resistance case to heatsink | | | 0.42 | | K/W | |

Output Inverter D1 - D6

| Symbol | Definitions | Conditions | Ratings | | | Unit |
|------------|-------------------------------------|---|---|--------------|------|---------------|
| | | | min. | typ. | max. | |
| V_{RRM} | max. repetitive reverse voltage | | $T_{VJ} = 25^{\circ}\text{C}$ | | 1200 | V |
| I_{F25} | forward current | | $T_C = 25^{\circ}\text{C}$ | | 33 | A |
| I_{F80} | | | $T_C = 80^{\circ}\text{C}$ | | 22 | A |
| V_F | forward voltage | $I_F = 20\text{ A}; V_{GE} = 0\text{ V}$ | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | 1.95 1.95 | 2.2 | V V |
| Q_{rr} | reverse recovery charge | $V_R = 600\text{ V}$ $di_F/dt = -400\text{ A}/\mu\text{s}$ $I_F = 20\text{ A}; V_{GE} = 0\text{ V}$ | $T_{VJ} = 125^{\circ}\text{C}$ | | 3 | μC |
| I_{RM} | max. reverse recovery current | | | | 20 | A |
| t_{rr} | reverse recovery time | | | | 350 | ns |
| E_{rec} | reverse recovery energy | | | | 0.7 | mJ |
| R_{thJC} | thermal resistance junction to case | (per diode) | | | 1.5 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | | 0.5 | | K/W |

Brake T7

| Symbol | Definitions | Conditions | Ratings | | | Unit |
|--|---------------------------------------|---|--------------------------------|------|-------------|----------|
| | | | min. | typ. | max. | |
| V_{CES} | collector emitter voltage | $T_{VJ} = 25^{\circ}\text{C}$ | | | 1200 | V |
| V_{GES} | max. DC gate voltage | continuous | | | ± 20 | V |
| V_{GEM} | max. transient collector gate voltage | transient | | | ± 30 | V |
| I_{C25} | collector current | $T_C = 25^{\circ}\text{C}$ | | | 28 | A |
| I_{C80} | | $T_C = 80^{\circ}\text{C}$ | | | 20 | A |
| P_{tot} | total power dissipation | $T_C = 25^{\circ}\text{C}$ | | | 100 | W |
| $V_{CE(sat)}$ | collector emitter saturation voltage | $I_C = 16\text{ A}; V_{GE} = 15\text{ V}$ | | | 1.8 2.1 | V V |
| $V_{GE(th)}$ | gate emitter threshold voltage | $I_C = 0.6\text{ mA}; V_{GE} = V_{CE}$ | 5 | 5.5 | 6.5 | V |
| I_{CES} | collector emitter leakage current | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$ | | | 0.01 0.1 | mA mA |
| I_{GES} | gate emitter leakage current | $V_{GE} = \pm 20\text{ V}$ | | | 500 | nA |
| $Q_{G(on)}$ | total gate charge | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 15\text{ A}$ | | 48 | | nC |
| $t_{d(on)}$ | turn-on delay time | inductive load $V_{CE} = 600\text{ V}; I_C = 15\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 56\ \Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ | | 70 | ns |
| t_r | current rise time | | | | 40 | ns |
| $t_{d(off)}$ | turn-off delay time | | | | 250 | ns |
| t_f | current fall time | | | | 100 | ns |
| E_{on} | turn-on energy per pulse | | | | 1.55 | mJ |
| E_{off} | turn-off energy per pulse | | | | 1.7 | mJ |
| RBSOA | reverse bias safe operating area | $V_{GE} = \pm 15\text{ V}; R_G = 56\ \Omega; V_{CEK} = 1200\text{ V}$ | | | 45 | A |
| | | $T_{VJ} = 125^{\circ}\text{C}$ | | | | |
| I_{SC} (SCSOA) | short circuit safe operating area | $V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V};$ $R_G = 56\ \Omega; t_p = 10\ \mu\text{s};$ non-repetitive | | 60 | | A |
| R_{thJC} | thermal resistance junction to case | (per IGBT) | | | 1.26 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | 0.42 | | | K/W |

Brake Chopper D7

| Symbol | Definitions | Conditions | Ratings | | | Unit |
|------------|-------------------------------------|---|--------------------------------|------|--------------|---------------|
| | | | min. | typ. | max. | |
| V_{RRM} | max. repetitive reverse voltage | $T_{VJ} = 150^{\circ}\text{C}$ | | | 1200 | V |
| I_{F25} | forward current | $T_C = 25^{\circ}\text{C}$ | | | 12 | A |
| I_{F80} | | $T_C = 80^{\circ}\text{C}$ | | | 8 | A |
| V_F | forward voltage | $I_F = 5\text{ A}; V_{GE} = 0\text{ V}$ | | | 1.95 1.95 | V V |
| I_R | reverse current | $V_R = V_{RRM}$ | | | 0.01 0.1 | mA mA |
| Q_{rr} | reverse recovery charge | $V_R = 600\text{ V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ $I_F = 5\text{ A}; V_{GE} = 0\text{ V}$ | $T_{VJ} = 125^{\circ}\text{C}$ | | 0.6 | μC |
| I_{RM} | max. reverse recovery current | | | | 6 | A |
| t_{rr} | reverse recovery time | | | | 350 | ns |
| E_{rec} | reverse recovery energy | | | | 0.15 | mJ |
| R_{thJC} | thermal resistance junction to case | (per diode) | | | 3.4 | K/W |
| R_{thCH} | thermal resistance case to heatsink | | 1.1 | | | K/W |

Input Rectifier Bridge D8 - D11

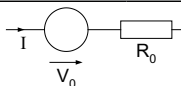
| Symbol | Definitions | Conditions | Ratings | | | Unit |
|------------|-------------------------------------|-------------------------|---|--------------|------------|--|
| | | | min. | typ. | max. | |
| V_{RRM} | max. repetitive reverse voltage | | $T_{VJ} = 25^{\circ}\text{C}$ | | 1600 | V |
| I_{FAV} | average forward current | sine 180° | $T_C = 80^{\circ}\text{C}$ | | 24 | A |
| I_{DAVM} | max. average DC output current | rect.; $d = 1/3$ | $T_C = 80^{\circ}\text{C}$ | | 69 | A |
| I_{FSM} | max. forward surge current | $t = 10$ ms; sine 50 Hz | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | | 270 240 | A A |
| I^2t | I^2t value for fusing | $t = 10$ ms; sine 50 Hz | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | | 360 290 | A^2s A^2s |
| P_{tot} | total power dissipation | | $T_C = 25^{\circ}\text{C}$ | | 69 | W |
| V_F | forward voltage | $I_F = 30$ A | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | 1.27 1.24 | 1.6 | V V |
| I_R | reverse current | $V_R = V_{RRM}$ | $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$ | 0.3 | 0.01 | mA mA |
| R_{thJC} | thermal resistance junction to case | (per diode) | | | 1.8 | K/W |
| R_{thCH} | thermal resistance case to heatsink | (per diode) | | 0.6 | | K/W |

Temperature Sensor NTC

| Symbol | Definitions | Conditions | Ratings | | | Unit |
|-------------|-------------|------------|----------------------------|------|------|-------------------|
| | | | min. | typ. | max. | |
| R_{25} | resistance | | $T_C = 25^{\circ}\text{C}$ | 4.75 | 5.0 | 5.25 k Ω |
| $B_{25/50}$ | | | | | 3375 | K |

Module

| Symbol | Definitions | Conditions | Ratings | | | Unit |
|------------|-----------------------------------|--------------------------------|---------|------|------|--------------------|
| | | | min. | typ. | max. | |
| T_{VJ} | operating temperature | | -40 | | 125 | $^{\circ}\text{C}$ |
| T_{VJM} | max. virtual junction temperature | | | | 150 | $^{\circ}\text{C}$ |
| T_{stg} | storage temperature | | -40 | | 125 | $^{\circ}\text{C}$ |
| V_{ISOL} | isolation voltage | $I_{ISOL} \leq 1$ mA; 50/60 Hz | | | 2500 | V~ |
| CTI | comparative tracking index | | | | - | |
| F_C | mounting force | | 40 | | 80 | N |
| d_S | creep distance on surface | | 12.7 | | | mm |
| d_A | strike distance through air | | 12 | | | mm |
| Weight | | | | 35 | | g |

Equivalent Circuits for Simulation


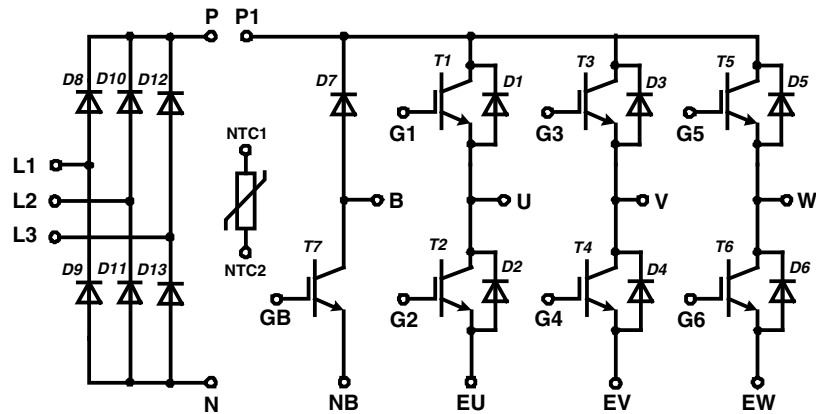
| Symbol | Definitions | Conditions | Ratings | | | Unit |
|--------|---------------------|------------|--------------------------------|------|------|------------------|
| | | | min. | typ. | max. | |
| V_0 | rectifier diode | D8 - D13 | $T_{VJ} = 150^{\circ}\text{C}$ | | 0.86 | V |
| R_0 | | | | | 12.3 | $\text{m}\Omega$ |
| V_0 | IGBT | T1 - T6 | $T_{VJ} = 150^{\circ}\text{C}$ | | 1.1 | V |
| R_0 | | | | | 86.3 | $\text{m}\Omega$ |
| V_0 | free wheeling diode | D1 - D6 | $T_{VJ} = 150^{\circ}\text{C}$ | | 1.19 | V |
| R_0 | | | | | 40.0 | $\text{m}\Omega$ |
| V_0 | IGBT | T7 | $T_{VJ} = 150^{\circ}\text{C}$ | | 1.1 | V |
| R_0 | | | | | 86.3 | $\text{m}\Omega$ |
| V_0 | free wheeling diode | D7 | $T_{VJ} = 150^{\circ}\text{C}$ | | 1.15 | V |
| R_0 | | | | | 171 | $\text{m}\Omega$ |

IXYS reserves the right to change limits, test conditions and dimensions.

 $T_C = 25^{\circ}\text{C}$ unless otherwise stated

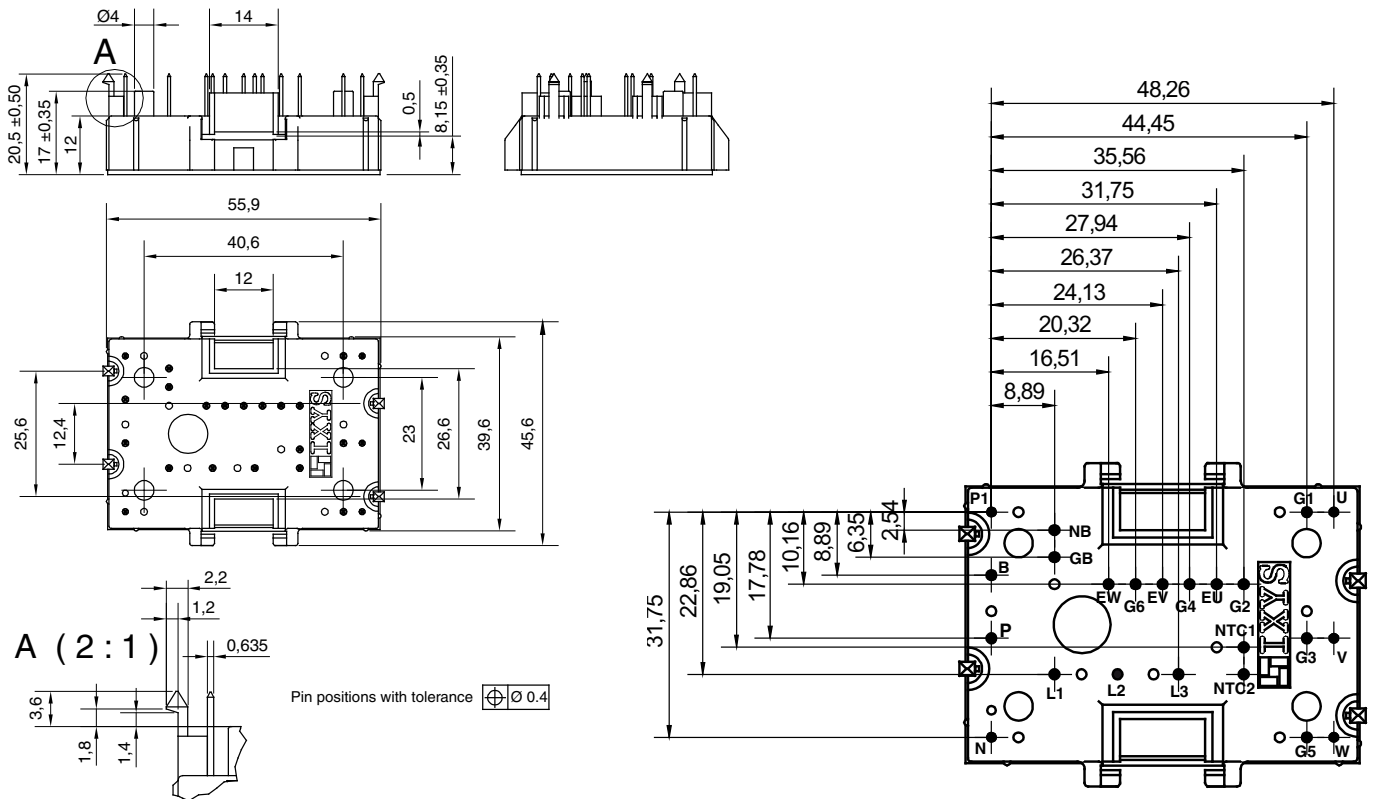
20101103b

Circuit Diagram

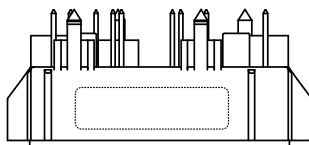


Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking



Part number

- M = Module
- I = IGBT
- X = XPT
- A = standard
- 20 = Current Rating [A]
- WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit
- 1200 = Reverse Voltage [V]
- T = NTC
- MH = MiniPack2

| Ordering | Part Name | Marking on Product | Delivering Mode | Base Qty | Ordering Code |
|----------|---------------------|--------------------|-----------------|----------|---------------|
| Standard | MIXA 20 WB 1200 TMH | MIXA20WB1200TMH | Box | 20 | 508616 |

IGBT T1 - T6

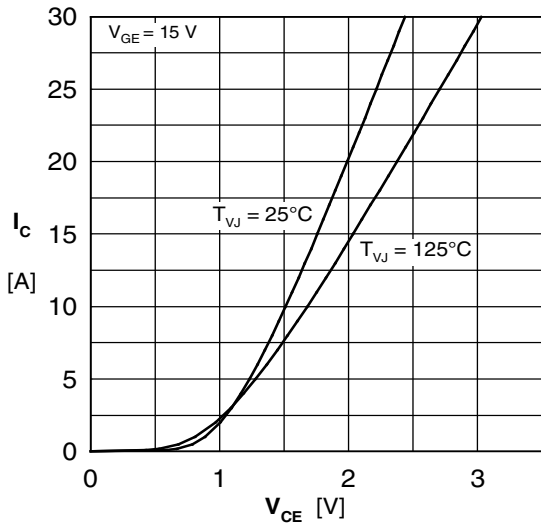


Fig. 1 Typ. output characteristics

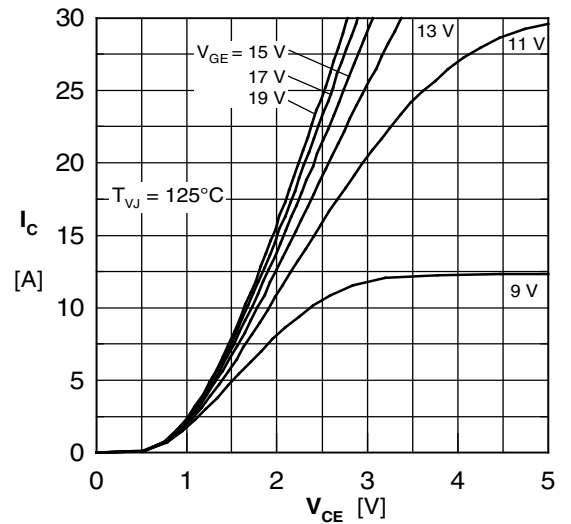


Fig. 2 Typ. output characteristics

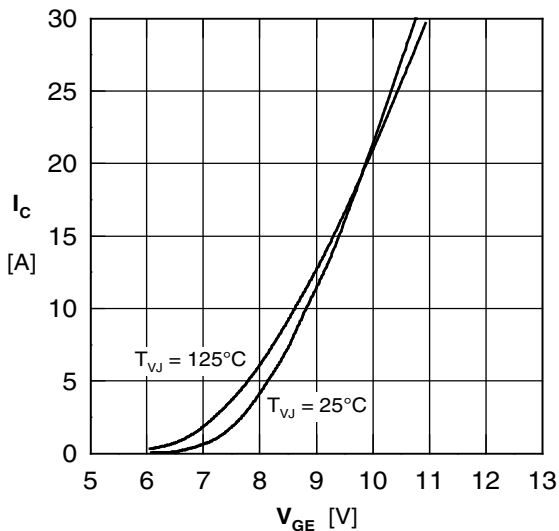


Fig. 3 Typ. transfer characteristics

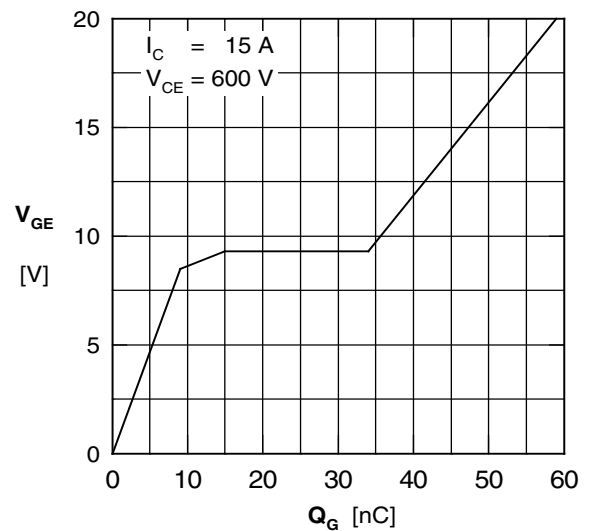


Fig. 4 Typ. turn-on gate charge

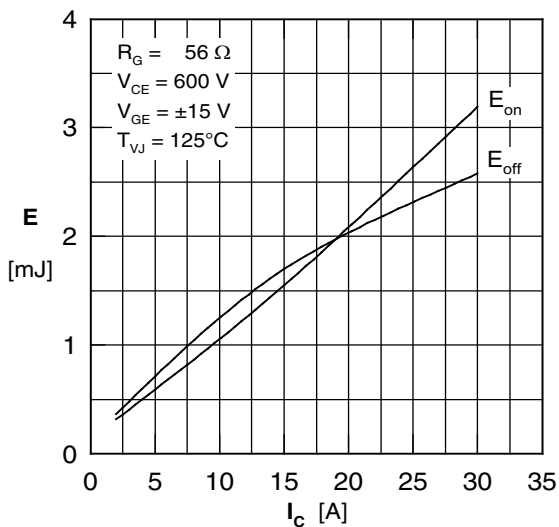


Fig. 5 Typ. switching energy vs. collector current

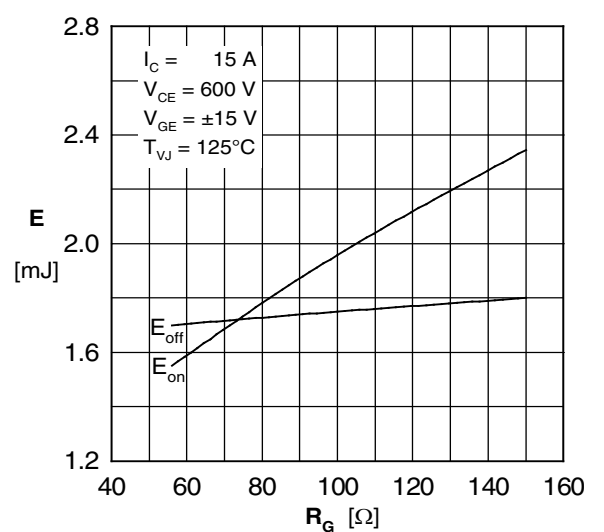


Fig. 6 Typ. switching energy vs. gate resistance

Diode D1 - D6

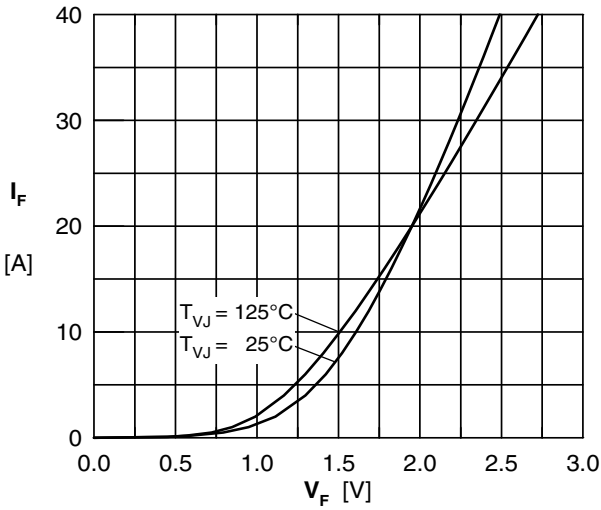


Fig. 7 Typ. Forward current versus V_F

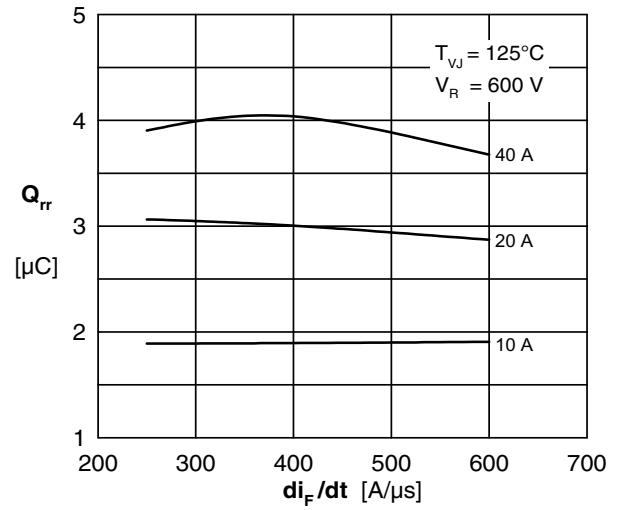


Fig. 8 Typ. reverse recov.charge Q_{rr} vs. di/dt

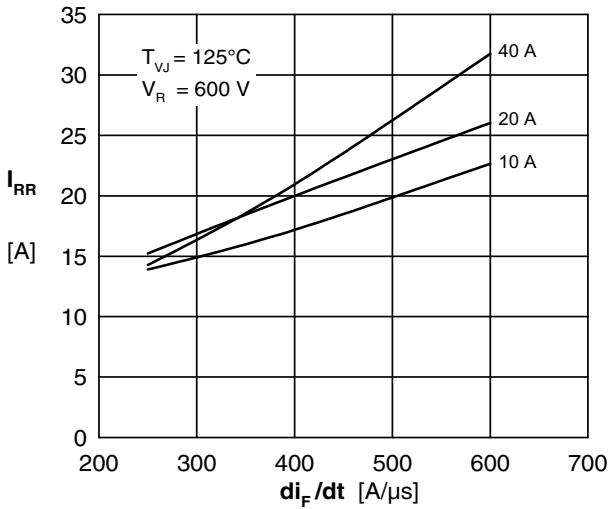


Fig. 9 Typ. peak reverse current I_{RRM} vs. di/dt

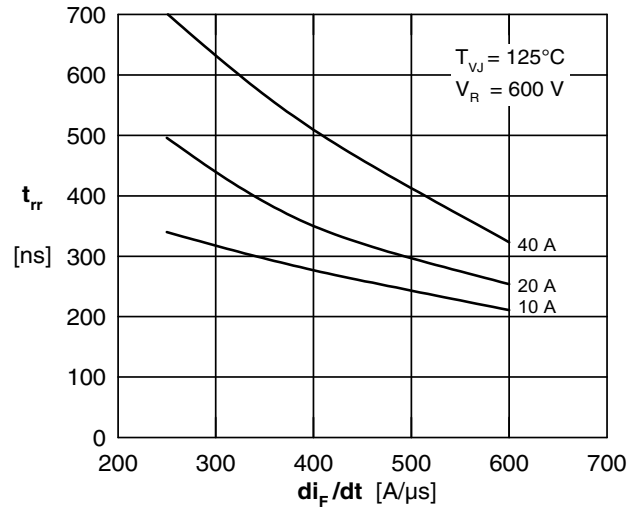


Fig. 10 Typ. recovery time t_{rr} versus di/dt

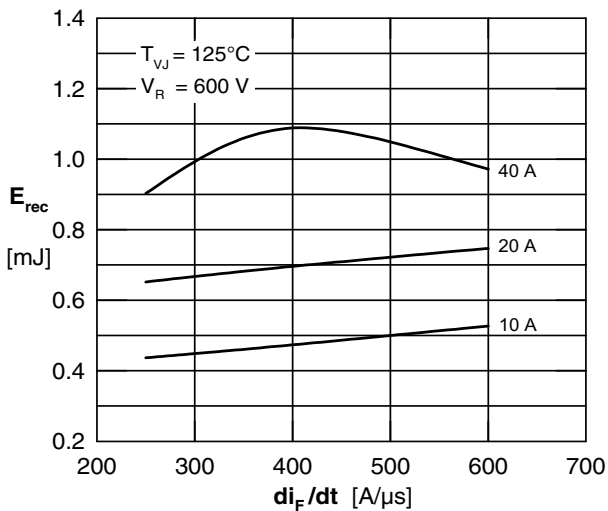


Fig. 11 Typ. recovery energy E_{rec} versus di/dt

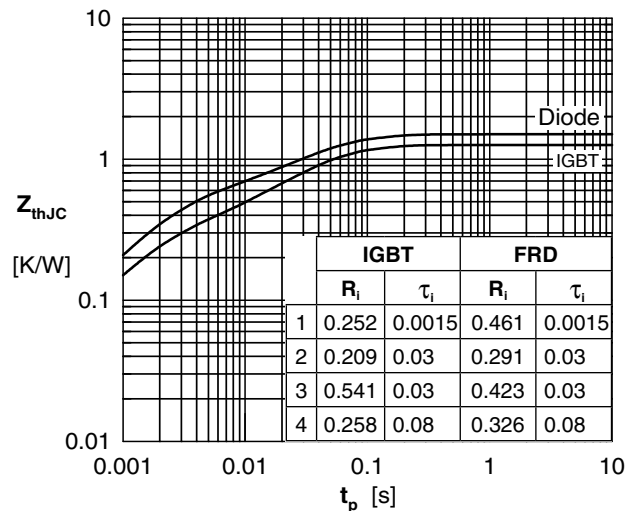


Fig. 12 Typ. transient thermal impedance

NTC

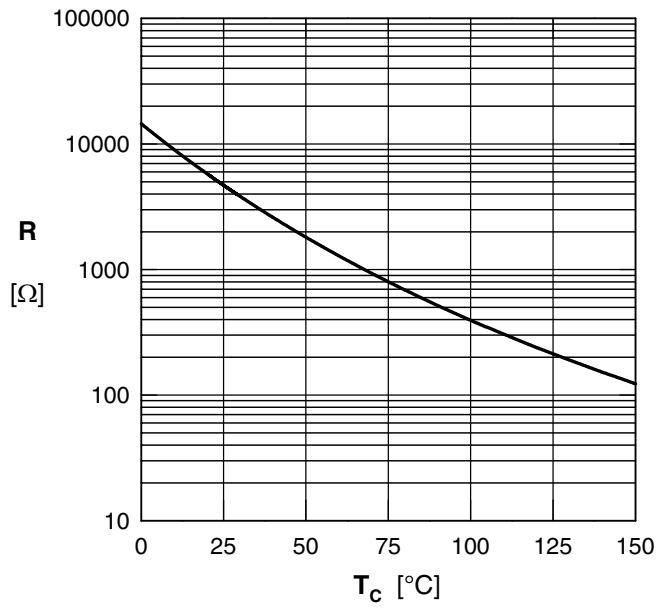


Fig. 13 Typ. thermistor resistance vs. temperature